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上海復旦微電子集團股份有限公司  
**Shanghai Fudan Microelectronics Group Company Limited\***  
*(a joint stock limited company incorporated in the People's Republic of China)*

(Stock Code: 1385)

**SUPPLEMENTAL ANNOUNCEMENT TO  
 THE ANNUAL REPORT FOR THE YEAR ENDED 31 DECEMBER 2018 AND  
 THE INTERIM REPORT FOR THE SIX MONTHS ENDED 30 JUNE 2019**

Reference is made to the annual report for the year ended 31 December 2018 (the “2018 Annual Report”) and the interim report for the six months ended 30 June 2019 (the “2019 Interim Report”) of Shanghai Fudan Microelectronics Group Company Limited (the “Company”). Unless otherwise stated, terms used herein shall bear the same meanings as those defined in the 2018 Annual Report and 2019 Interim Report.

In the 2018 Annual Report and 2019 Interim Report, the Company has disclosed the use of net proceeds from placements of H shares and Domestic shares for the relevant periods respectively for the year ended 31 December 2018 and for the six months ended 30 June 2019 (the “Relevant Periods”). The board of directors of the Company would like to provide supplemental information in respect of the net proceeds utilised in the Relevant Period in the tables set out below:

	Balance of unutilised net proceeds as at 1 January 2018 RMB'000	Net proceeds from placement in 2018 RMB'000	Amount utilised for the year ended 31 December 2018 RMB'000	Amount unutilised as at 31 December 2018 RMB'000	Amount utilised for the six months ended 30 June 2019 RMB'000	Amount unutilised as at 30 June 2019 RMB'000
H shares placement	143,316	-	98,284	45,032	45,032	-
Domestic shares placement	-	200,715	71,844	128,871	128,871	-
	<u>143,316</u>	<u>200,715</u>	<u>170,128</u>	<u>173,903</u>	<u>173,903</u>	<u>-</u>

Details of the net proceeds utilised as general working capital are as follows:

	Amount utilised for the year ended 31 December 2018 RMB'000	Amount utilised for the six months ended 30 June 2019 RMB'000
<u>H shares placement</u>		
Trade payables and sub-contracting charges	97,511	43,370
Administrative expenses	773	475
Exchange loss	-	1,187
	98,284	45,032
<u>Domestic shares placement</u>		
Trade payables and sub-contracting charges	61,177	82,093
Salaries	1,876	6,804
Research and development expenditure	3,728	7,321
Tax expenses	5,063	32,653
	71,844	128,871
Total	170,128	173,903

The above supplemental information does not affect other information contained in the 2018 Annual Report and the 2019 Interim Report. Save as disclosed in this announcement, the remaining contents of the 2018 Annual Report and the 2019 Interim Report remain unchanged.

By order of the Board  
**Shanghai Fudan Microelectronics Group Company Limited\***  
**Jiang Guoxing**  
*Chairman*

Shanghai, the PRC, 16 October 2019

As at the date of this announcement, the Company's executive directors are Mr. Jiang Guoxing, Mr. Shi Lei, Mr. Yu Jun and Ms. Cheng Junxia; non-executive directors are Ms. Zhang Qianling, Mr. Ma Zhicheng, Ms. Zhang Huajing and Mr. Wu Ping, and independent non-executive directors are Mr. Guo Li, Mr. Cao Zhongyong, Mr. Cai Minyong and Mr. Wang Pin.

\* *For identification only*